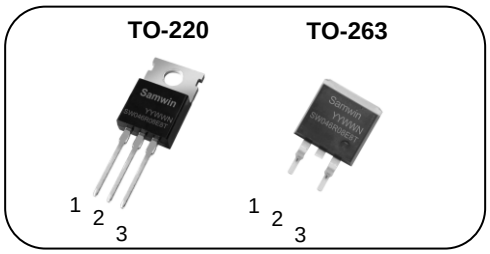
N-channel Enhanced mode TO-220/TO-263 MOSFET

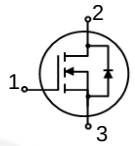
Features

- High ruggedness
- Low $R_{DS(ON)}$ (Typ 4.8mΩ)@V_{GS}=10V
- Low Gate Charge (Typ 183nC)
- Improved dv/dt Capability
- 100% Avalanche Tested
- Application:Synchronous Rectification, Li Battery Protect Board, Inverter



1. Gate 2.Drain 3.Source

BV_{DSS} : 80V
I_D : 150A
$R_{DS(ON)}$: 4.8mΩ



General Description

This power MOSFET is produced with advanced technology of SAMWIN. This technology enable the power MOSFET to have better characteristics, including fast switching time, low on resistance, low gate charge and especially excellent avalanche characteristics.

LEAD-FREE RoHS

Order Codes

Item	Sales Type	Marking	Package	Packaging
1	SW P 046R08E8T	SW046R08E8T	TO-220	TUBE
2	SW B 046R08E8T	SW046R08E8T	TO-263	TUBE

Absolute maximum ratings

Symbol	Parameter		Value		Unit
			TO-220	TO-263	
V_{DSS}	Drain to source voltage		80		V
I_D	Continuous drain current (@T_C=25°C)		150*		A
	Continuous drain current (@T_C=100°C)		102*		A
I_{DM}	Drain current pulsed	(note 1)	600		A
V_{GS}	Gate to source voltage		±20		V
E_{AS}	Single pulsed avalanche energy	(note 2)	361		mJ
E_{AR}	Repetitive avalanche energy	(note 1)	30		mJ
dv/dt	Peak diode recovery dv/dt	(note 3)	5		V/ns
P_D	Total power dissipation (@T_C=25°C)		227.3		W
	Derating factor above 25°C		1.8		W/°C
T_{STG}, T_J	Operating junction temperature & storage temperature		-55 ~ + 150		°C
T_L	Maximum lead temperature for soldering purpose, 1/8 from case for 5 seconds.		300		°C

*. Drain current is limited by junction temperature.

Thermal characteristics

Symbol	Parameter	Value		Unit
		TO-220	TO-263	
R_{thjc}	Thermal resistance, Junction to case	0.55		°C/W
R_{thja}	Thermal resistance, Junction to ambient	50.5		°C/W

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Electrical characteristic (T_J = 25ºC unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
Off characteristics						
BV_{DSS}	Drain to source breakdown voltage	V_{GS}=0V, I_D=250uA	80			V
ΔBV_{DSS} / ΔT_J	Breakdown voltage temperature coefficient	I_D=250uA, referenced to 25ºC		0.06		V/ºC
I_{DSS}	Drain to source leakage current	V_{DS}=80V, V_{GS}=0V			1	uA
		V_{DS}=64V, T_J=125ºC			50	uA
I_{GSS}	Gate to source leakage current, forward	V_{GS}=20V, V_{DS}=0V			100	nA
	Gate to source leakage current, reverse	V_{GS}=-20V, V_{DS}=0V			-100	nA
On characteristics						
$V_{GS(TH)}$	Gate threshold voltage	V_{DS}=V_{GS}, I_D=250uA	2		4	V
$R_{DS(ON)}$	Drain to source on state resistance	V_{GS}=10V, I_D=30A,T_J=25ºC		4.8	5.9	mΩ
		V_{GS}=10V, I_D=30A,T_J=125ºC		8.3		mΩ
G_{fs}	Forward transconductance	V_{DS}=5V, I_D=30A		60		S
Dynamic characteristics						
C_{iss}	Input capacitance	V_{GS}=0V, V_{DS}=40V, f=1MHz		8422		pF
C_{oss}	Output capacitance			660		
C_{rss}	Reverse transfer capacitance			401		
$t_{d(on)}$	Turn on delay time	V_{DS}=40V, I_D=30A, R_G=4.7Ω, V_{GS}=10V (note 4,5)		36		ns
t_r	Rising time			85		
$t_{d(off)}$	Turn off delay time			154		
t_f	Fall time			63		
Q_g	Total gate charge	V_{DS}=64V, V_{GS}=10V, I_D=30A , I_G=10mA (note 4,5)		183		nC
Q_{gs}	Gate-source charge			42		
Q_{gd}	Gate-drain charge			67		
R_g	Gate resistance	V_{DS}=0V, Scan F mode		3.2		Ω

Source to drain diode ratings characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_S	Continuous source current	Integral reverse p-n Junction diode in the MOSFET			150	A
I_{SM}	Pulsed source current				600	A
V_{SD}	Diode forward voltage drop.	I_S=45A, V_{GS}=0V			1.4	V
t_{rr}	Reverse recovery time	I_S=30A, V_{GS}=0V, dI_F/dt=100A/us		46		ns
Q_{rr}	Reverse recovery charge			83		nC

※. Notes

1. Repeatitive rating : pulse width limited by junction temperature.
2. L =0.5mH, I_{AS} =38A, V_{DD}=50V, R_G=25Ω, Starting T_J = 25ºC
3. I_{SD} ≤30A, di/dt = 100A/us, V_{DD} ≤ BV_{DSS}, Staring T_J =25ºC
4. Pulse Test : Pulse Width ≤ 300us, duty cycle ≤ 2%.
5. Essentially independent of operating temperature.

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Fig. 1. On-state characteristics

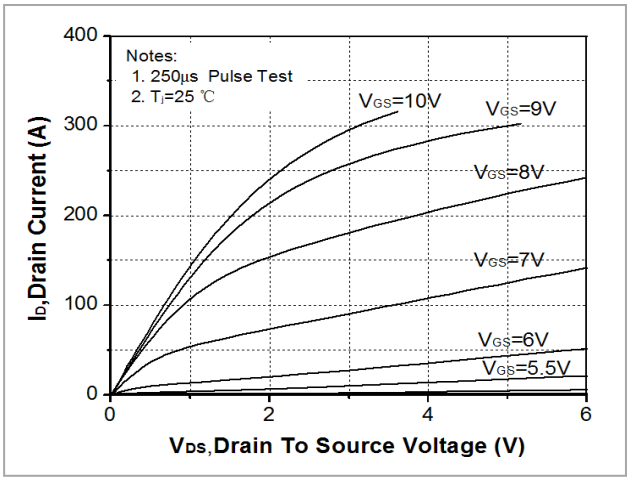

Fig. 2. Transfer Characteristics

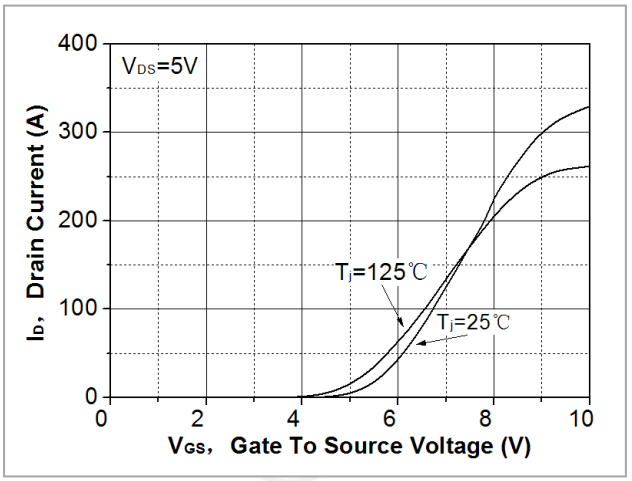

Fig. 3. On-resistance variation vs. drain current and gate voltage

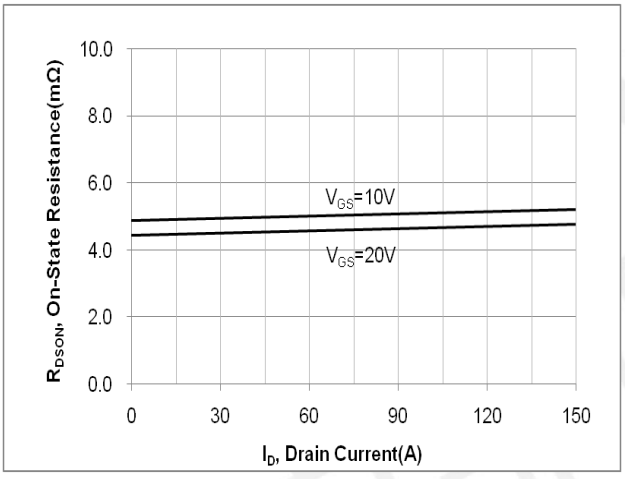

Fig. 4. On-state current vs. diode forward voltage

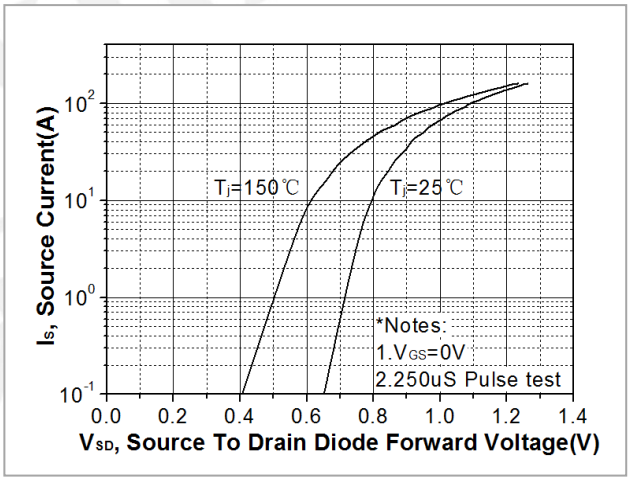

Fig 5. Breakdown voltage variation vs. junction temperature

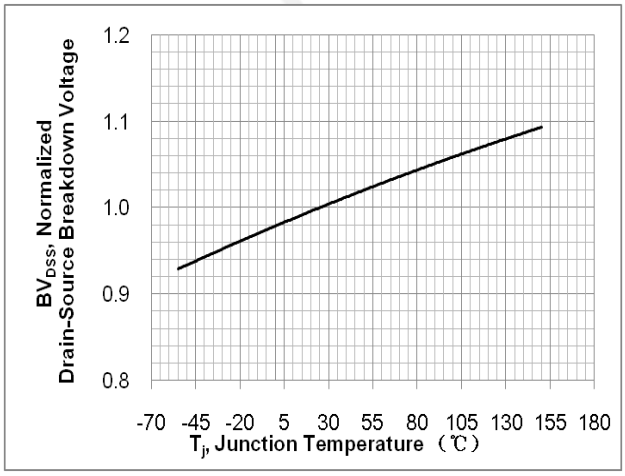

Fig. 6. On-resistance variation vs. junction temperature

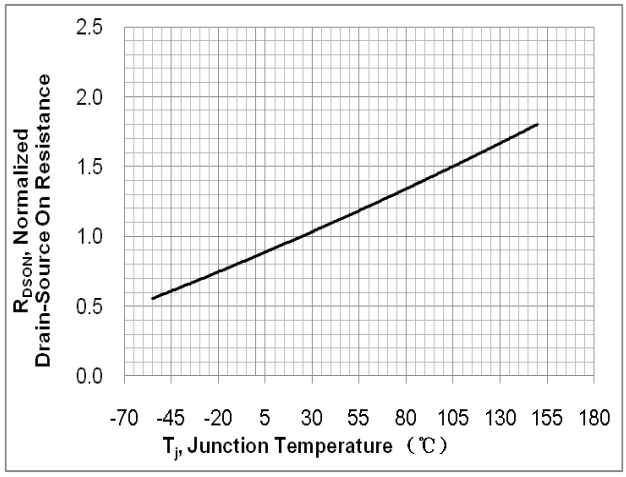

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Fig. 7. Gate charge characteristics

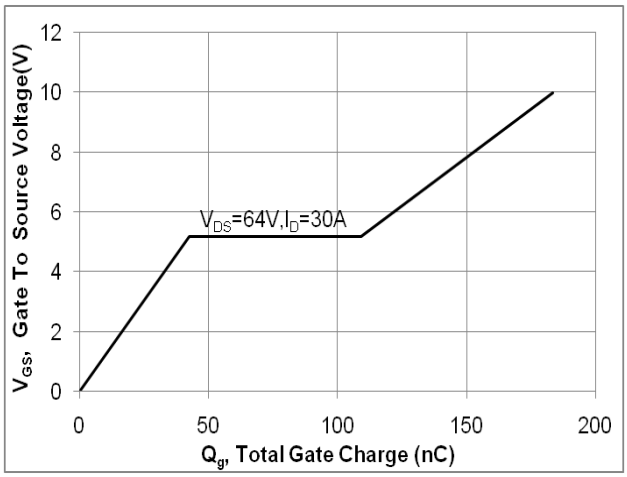

Fig. 8. Capacitance Characteristics

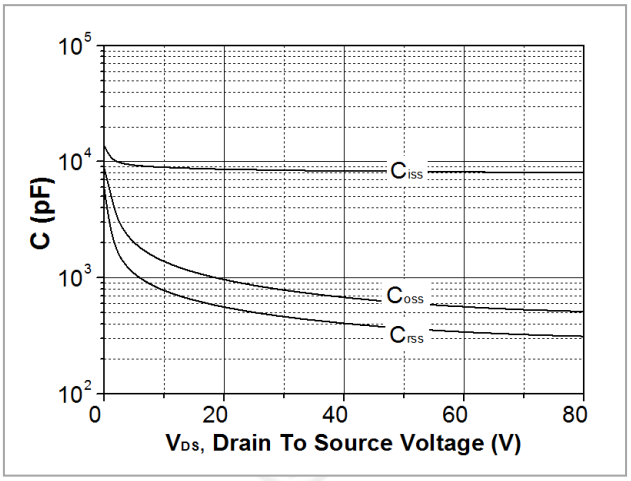

Fig. 9. Maximum safe operating area

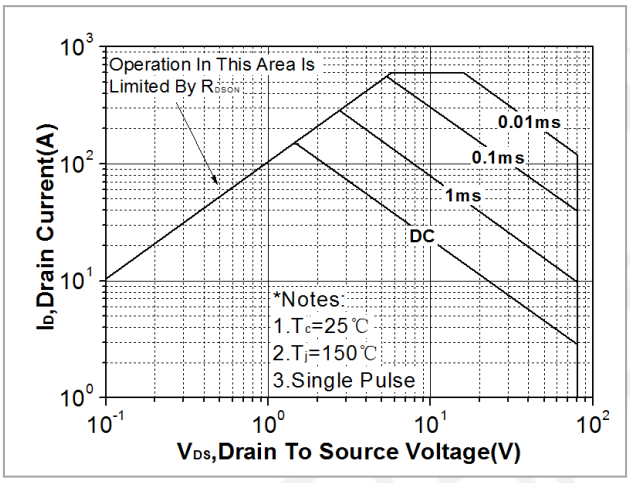

Fig. 10. Maximum drain current vs. case temperature

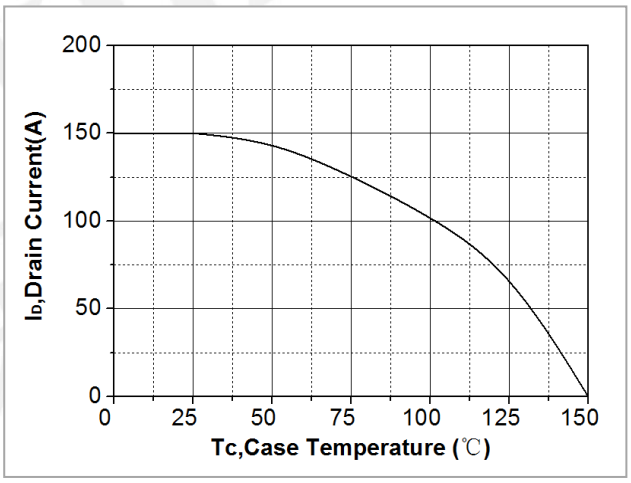

Fig. 11. Transient thermal response curve

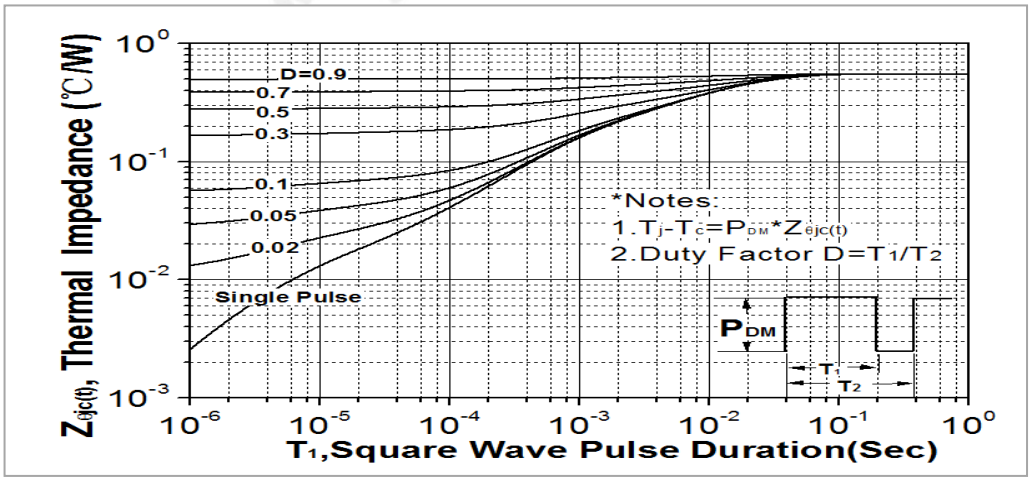

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Fig. 12. Gate charge test circuit & waveform

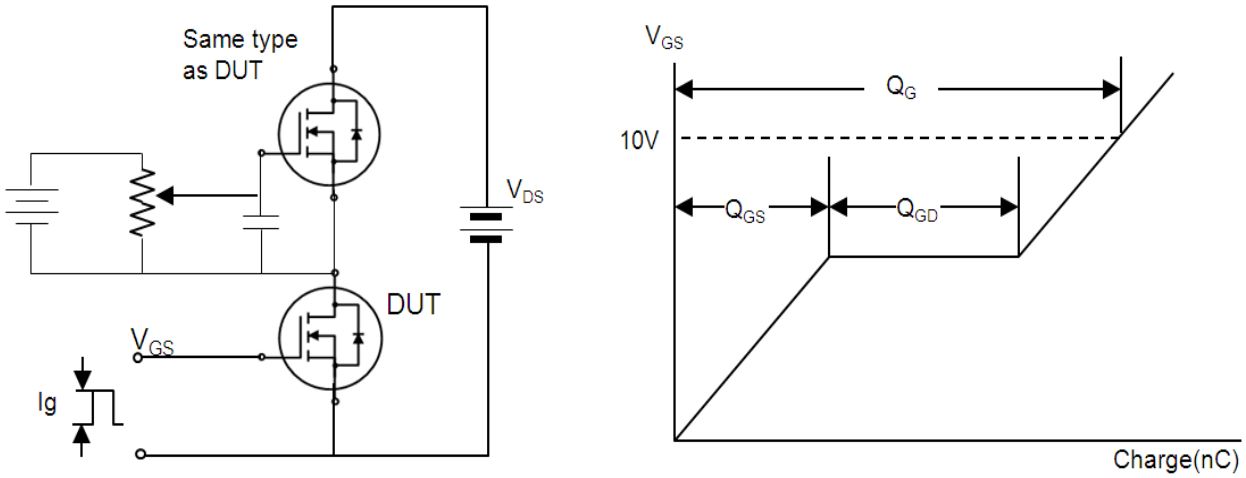


Fig. 13. Switching time test circuit & waveform

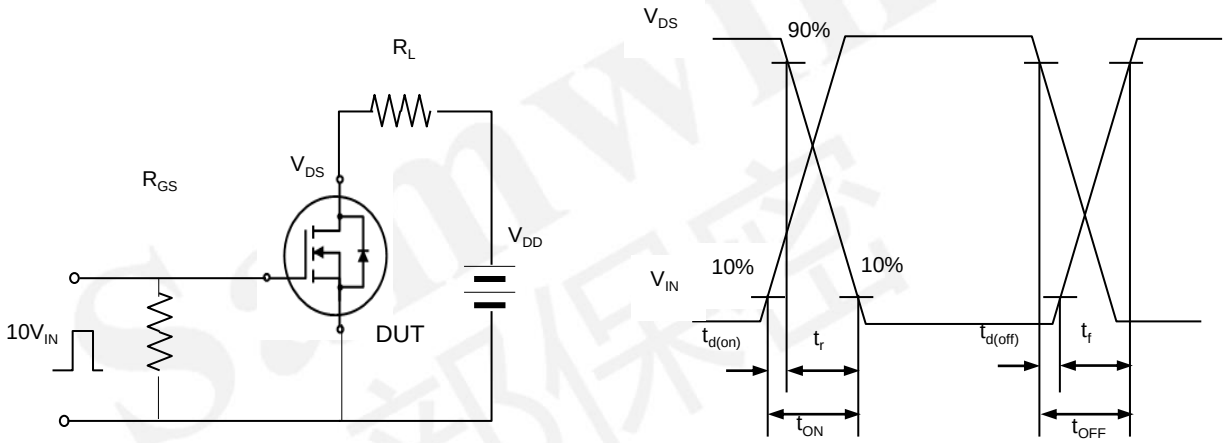
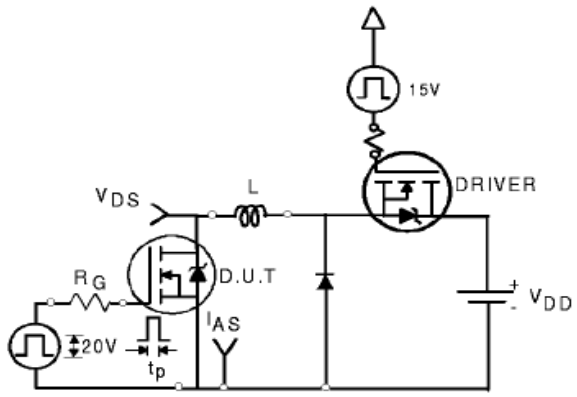


Fig. 14. Unclamped Inductive switching test circuit & waveform



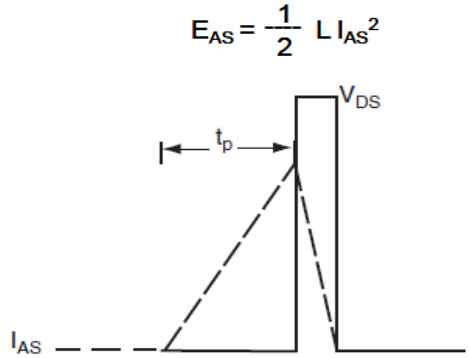


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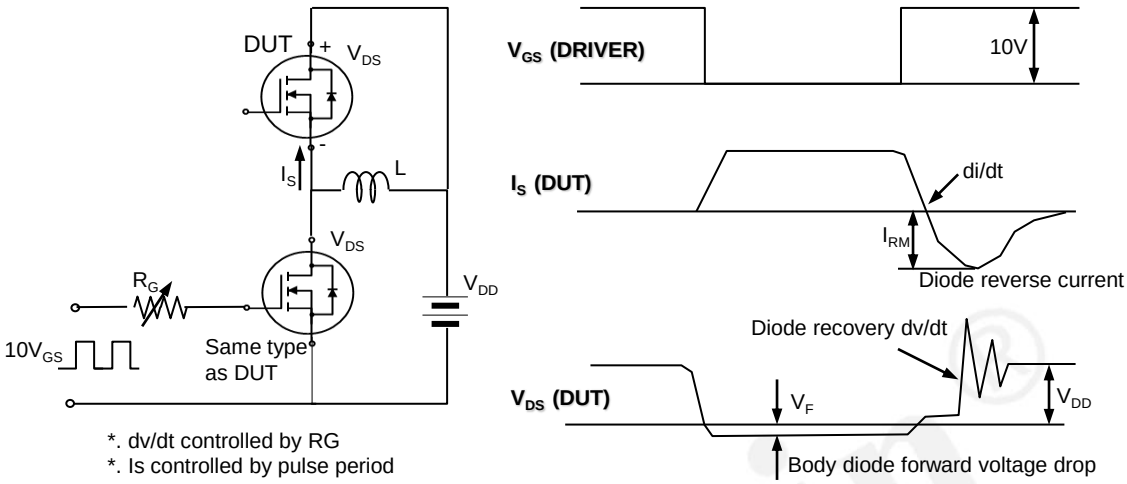
Fig. 15. Peak diode recovery dv/dt test circuit & waveform



Samwin 内部保密

DISCLAIMER

* All the data & curve in this document was tested in SEMIPOWER TESTING & APPLICATION CENTER.
* This product has passed the PCT,TC,HTRB,HTGB,HAST,PC and Solderdunk reliability testing.
* Qualification standards can also be found on the Web site (**http://www.semipower.com.cn**)
* Suggestions for improvement are appreciated, Please send your suggestions to **samwin@samwinsemi.com**

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